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503.39864X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): T. SATOH, et al

Serial No.: 09/809,181

Filed: March 16, 2001

For: SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD
THEREOF

Group: 2812

Examiner:

#10/Pre.
B
marsha
1/22/02

PRELIMINARY AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

October 16, 2001

Sir:

The following preliminary amendments and remarks are respectfully submitted in connection with the above-identified application.

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TC 2800 MAIL ROOM

IN THE SUBSTITUTE SPECIFICATION:

Please replace the Substitute Specification filed on August 20, 2001 with the attached new Replacement Substitute Specification.

IN THE CLAIMS:

Please amend the claim 10 as follows:

10. (amended) A semiconductor device according to any of Claims 4 to [9] 7, wherein an end area of said stress

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